flex

Technical Specification

PKU4116C Series Direct Converters
Input 36-75 V, Output up to 3.3 A /100 W

28701-BMR67105 Rev.F

September 2019

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Key Features

- Industry standard low profile Sixteenth-brick 33.02 x 22.86 x 9.6 mm (1.30 x 0.90 x 0.38 in)
- High efficiency, typ. 93 % at 30 Vout full load
- Open frame intended for conducted cooling (cold wall)
- 1500 Vdc input to output isolation
- N+1 parallelable
- Meets safety requirements according to IEC/EN/UL 62368-1
- MTBF 5.2 Mh

General Characteristics

- Output over voltage protection
- Input under voltage shutdown
- Over temperature protection
- Monotonic start-up
- · Output short-circuit protection
- · Remote control
- Output voltage adjust function from 10 to 33 V
- · Highly automated manufacturing ensures quality
- ISO 9001/14001 certified supplier



Safety Approvals





Design for Environment





Meets requirements in hightemperature lead-free soldering processes.

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PKU4116C Series Direct Converters Input 36-75 V, Output up to 3.3 A /100 W 28701-BMR67105 Rev.F September 2019 © Flex

Ordering Information

| Product program | Output |
|-----------------|---------------------|
| PKU4116C | 30 V, 3.3 A / 100 W |

Product number and Packaging

| PKU4116Cn ₁ n ₂ n ₃ n ₄ n ₅ | | | | | | | |
|--|----------------|----------------|----------------|----------------|----------------|--|--|
| Options | n ₁ | n ₂ | n ₃ | n ₄ | n ₅ | | |
| Mounting | o | | | | | | |
| Remote Control logic | | О | | | | | |
| Baseplate | | | О | | | | |
| Lead length | | | | О | | | |
| Delivery package information | | | | | 0 | | |

| Options | Desc | cription |
|----------------|----------------|--|
| n ₁ | SI PI | Surface mount Through hole |
| n_2 | Р | Negative * Positive |
| n_3 | HS | Open frame * Baseplate |
| n ₄ | LA LB LC | 5.30 mm * 3.69 mm (Pin-cut) 4.57 mm (Pin-cut) 2.79 mm (Pin-cut) |
| n_4 | /B /C | Tray Tape and Reel |

Example an open frame, surface mounted, negative logic product with tray packaging would be PKU4116CSI/B

General Information

Reliability

The failure rate (λ) and mean time between failures (MTBF= $1/\lambda)$ is calculated at max output power and an operating ambient temperature (TA) of +40°C. Flex Power Modules uses Telcordia SR-332 Issue 2 Method 1 to calculate the mean steady-state failure rate and standard deviation $(\sigma).$

Telcordia SR-332 Issue 2 also provides techniques to estimate the upper confidence levels of failure rates based on the mean and standard deviation.

| Mean steady-state failu | re rate, λ | Std. deviation, σ |
|-------------------------|------------|-------------------|
| 193 nFailures/h | | 27 nFailures/h |

MTBF (mean value) for the PKU4116C series = 5.18 Mh. MTBF at 90% confidence level = 4.38 Mh

Compatibility with RoHS requirements

The products are compatible with the relevant clauses and requirements of the RoHS directive 2011/65/EU and have a

maximum concentration value of 0.1% by weight in homogeneous materials for lead, mercury, hexavalent chromium, PBB and PBDE and of 0.01% by weight in homogeneous materials for cadmium.

Exemptions in the RoHS directive utilized in Flex Power Modules products are found in the Statement of Compliance document.

Flex Power Modules fulfills and will continuously fulfill all its obligations under regulation (EC) No 1907/2006 concerning the registration, evaluation, authorization and restriction of chemicals (REACH) as they enter into force and is through product materials declarations preparing for the obligations to communicate information on substances in the products.

Quality Statement

The products are designed and manufactured in an industrial environment where quality systems and methods like ISO 9000, Six Sigma, and SPC are intensively in use to boost the continuous improvements strategy. Infant mortality or early failures in the products are screened out and they are subjected to an ATE-based final test. Conservative design rules, design reviews and product qualifications, plus the high competence of an engaged work force, contribute to the high quality of the products.

Warranty

Warranty period and conditions are defined in Flex Power Modules General Terms and Conditions of Sale.

Limitation of Liability

Flex Power Modules does not make any other warranties, expressed or implied including any warranty of merchantability or fitness for a particular purpose (including, but not limited to, use in life support applications, where malfunctions of product can cause injury to a person's health or life).

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The information and specifications in this technical specification is believed to be correct at the time of publication. However, no liability is accepted for inaccuracies, printing errors or for any consequences thereof. Flex reserves the right to change the contents of this technical specification at any time without prior notice.

^{*} Standard variant (i.e. no option selected).



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Safety Specification

General information

Flex Power Modules DC/DC converters and DC/DC regulators are designed in accordance with the safety standards IEC 62368-1, EN 62368-1 and UL 62368-1 Safety of Information Technology Equipment.

IEC/EN/UL 62368-1 contains requirements to prevent injury or damage due to the following hazards:

- Electrical shock
- Energy hazards
- Fire
- · Mechanical and heat hazards
- · Radiation hazards
- Chemical hazards

On-board DC/DC converters and DC/DC regulators are defined as component power supplies. As components they cannot fully comply with the provisions of any safety requirements without "conditions of acceptability". Clearance between conductors and between conductive parts of the component power supply and conductors on the board in the final product must meet the applicable safety requirements. Certain conditions of acceptability apply for component power supplies with limited stand-off (see Mechanical Information and Safety Certificate for further information). It is the responsibility of the installer to ensure that the final product housing these components complies with the requirements of all applicable safety standards and regulations for the final product.

Component power supplies for general use should comply with the requirements in IEC/EN/UL 62368-1 Safety of Information Technology Equipment. Product related standards, e.g. IEEE 802.3af Power over Ethernet, and ETS-300132-2 Power interface at the input to telecom equipment, operated by direct current (dc) are based on IEC/EN/UL 62368-1 with regards to safety.

Flex Power Modules DC/DC converters, Power interface modules and DC/DC regulators are UL 62368-1 recognized and certified in accordance with EN 62368-1. The flammability rating for all construction parts of the products meet requirements for V-0 class material according to IEC 60695-11-10, *Fire hazard testing, test flames* – 50 W horizontal and vertical flame test methods.

Isolated DC/DC converters & Power interface modules

The product may provide basic or functional insulation between input and output according to IEC/EN/UL 62368-1 (see Safety Certificate), different conditions shall be met if the output of a basic or a functional insulated product shall be considered as safety extra low voltage (SELV).

For basic insulated products (see Safety Certificate) the output is considered as safety extra low voltage (SELV) if

one of the following conditions is met:

- The input source provides supplementary or double or reinforced insulation from the AC mains according to IEC/EN/UL 62368-1.
- The input source provides functional or basic insulation from the AC mains and the product's output is reliably connected to protective earth according to IEC/EN/UL 62368-1.

For functional insulated products (see Safety Certificate) the output is considered as safety extra low voltage (SELV) if one of the following conditions is met:

- The input source provides double or reinforced insulation from the AC mains according to IEC/EN/UL 62368-1.
- The input source provides basic or supplementary insulation from the AC mains and the product's output is reliably connected to protective earth according to IEC/EN/UL 62368-1.
- The input source is reliably connected to protective earth and provides basic or supplementary insulation according to IEC/EN/UL 62368-1 and the maximum input source voltage is 60 Vdc.

Galvanic isolation between input and output is verified in an electric strength test and the isolation voltage ($V_{\rm iso}$) meets the voltage strength requirement for basic insulation according to IEC/EN/UL 62368-1.

It is recommended to use a slow blow fuse at the input of each DC/DC converter. If an input filter is used in the circuit the fuse should be placed in front of the input filter. In the rare event of a component problem that imposes a short circuit on the input source, this fuse will provide the following functions:

- Isolate the fault from the input power source so as not to affect the operation of other parts of the system
- Protect the distribution wiring from excessive current and power loss thus preventing hazardous overheating

Non - isolated DC/DC regulators

The DC/DC regulator output is SELV if the input source meets the requirements for SELV circuits according to IEC/EN/UL 62368-1.



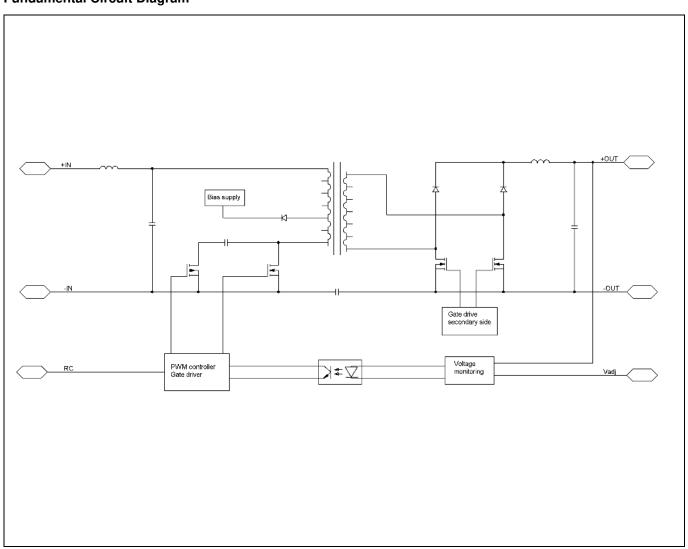
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|--|----------------------|----------------|
| Input 36-75 V, Output up to 3.3 A /100 W | © Flex | |

Absolute Maximum Ratings

| Char | Characteristics | | min | typ | max | Unit |
|------------------|---|--------------------------|------|-----|------|------|
| T _{P2} | Operating Temperature (see Thermal Consideration section | n) | -40 | | +125 | °C |
| Ts | Storage temperature | | -55 | | +125 | °C |
| Vı | V _I Input voltage | | -0.5 | | +80 | V |
| Cı | External input capacitance (see Operating Information section) | | 47 | | | μF |
| V _{iso} | V _{iso} Isolation voltage (input to output test voltage) | | | | 1500 | Vdc |
| V_{tr} | Input voltage transient according to ETSI EN 300 132-2 and | d Telcordia GR-1089-CORE | | | 100 | V |
| \/ | Remote Control pin voltage | Positive logic option | -0.5 | | 6 | V |
| V_{RC} | (see Operating Information section) | Negative logic option | -0.5 | | 6 | V |
| V_{adj} | Adjust pin voltage (see Operating Information section) | | -0.5 | | 5 | V |

Stress in excess of Absolute Maximum Ratings may cause permanent damage. Absolute Maximum Ratings, sometimes referred to as no destruction limits, are normally tested with one parameter at a time exceeding the limits in the Electrical Specification. If exposed to stress above these limits, function and performance may degrade in an unspecified manner.

Fundamental Circuit Diagram



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 V_{I}

 V_{loff}

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|--|----------------------|----------------|
| Input 36-75 V, Output up to 3.3 A /100 W | © Flex | |

Electrical Specification 24 V, 3.3 A / 80 W

Input voltage range

Turn-off input voltage

PKU 4116C

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75

35

 T_{P1} = -30 to +95°C, V_I = 36 to 75 V, unless otherwise specified under Conditions. Typical values given at: T_{P1} = +25°C, V_I = 48 V, max I_O , 82.94 kohm resistance on the Vadj-pin, unless otherwise specified under Conditions. Additional C_{in} = 47 μ F, C_{out} = 47 ν F. See Operating Information section for selection of capacitor types.

36

33

Decreasing input voltage

| V_{lon} | Turn-on input voltage | Increasing input voltage | 34 | 35 | 36 | ٧ |
|------------------|--|--|--------------|-----------|------------|--------|
| Cı | Internal input capacitance | | | 5 | | μF |
| Po | Output power | V ₁ = 75 V V ₁ = 60 V, See note 1 | 1 0.5 | | 80 | W |
| | Efficiency | 50% of max I _O | | 91.6 | | |
| l n | | max I _O | | 92.2 | | % |
| η | Linciency | 50% of max I_0 , $V_1 = 53 \text{ V}$ | | 91.1 | | /0 |
| ı | | $max I_O, V_I = 53 V$ | | 92.0 | | |
| P_{d} | Power Dissipation | max I _O | | 6.7 | 10.3 | W |
| Pii | Input idling power | $I_0 = 0 \text{ A}, V_1 = 48 \text{ V}$ | | 1.8 | | W |
| P_RC | Input standby power | V _I = 48 V (turned off with RC) | | 0.26 | | W |
| fs | Switching frequency | 0-100 % of max I _O | 370 | 415 | 460 | kHz |
| | | | | | | |
| V_{Oi} | Output voltage initial setting and accuracy | $T_{P1} = +25$ °C, $V_I = 48$ V, $I_O = 1.5$ A, See Note 2 | 23.75 | 24 | 24.25 | V |
| 1 | Output adjust range | See operating information | 10 | | 33 | V |
| Ì | Output voltage tolerance band | 1-100% of max I ₀ | 23.64 | | 24.36 | V |
| Vo | Idling voltage | $I_0 = 0 \text{ A}, V_1 = 75 \text{ V}$ $I_0 = 0 \text{ A}, V_1 = 60 \text{ V}$ | 23.64 | | 41 36.6 | V |
| 1 | Line regulation | $max I_{O_1} V_O = 24 V$ | | 1 | 9 | mV |
| ı | Load regulation | $V_1 = 48 \text{ V}, 1-100\% \text{ of max } I_0$ | | 0 | 10 | mV |
| V_{tr} | Load transient voltage deviation | V_1 = 48 V, Load step 25-75-25% of I_0 = 1.5A, di/dt = 1 A/ μ s, C_0 = 1mF | | 220 | 400 | mV |
| t _{tr} | Load transient recovery time | | | 0.6 | 1.5 | ms |
| t _r | Ramp-up time (from 10-90% of V _{Oi}) | 10-100% of max I _O | | 6 | 10 | ms |
| ts | Start-up time (from V _I connection to 90% of V _{Oi}) | | | 7.5 | 10 | ms |
| t _f | V _I shut-down fall time | max I _O | | 1.5 | | ms |
| | (from V _I off to 10% of V _O) | I _O = 0 A | | 12 | | S |
| ı. | RC start-up time | max I ₀ | | 115 | | ms |
| t _{RC} | RC shut-down fall time (from RC off to 10% of Vo) | max I _O | | 1.5 12 | | ms |
| Io | Output current | I _O = 0 A V _I = 75 V V _I = 60 V, See note 1 | 0.04 0.02 | 12 | 3.3 | S A |
| I _{lim} | Current limit threshold | $T_{P1} < max T_{P1}$ | 4.2 | 6.4 | 8 | Α |
| I _{sc} | Short circuit current | $T_{P1} = 25^{\circ}C$, hic-up mode | 7.2 | 4.5 | 5.5 | A |
| Cout | Recommended Capacitive Load | $T_{P1} = 25^{\circ}C$, see Note 4 | 47 | 1.0 | 1000 | μF |
| Voac | Output ripple & noise | See ripple & noise section, Voi | | 23 | 60 | mVp-p |
| OVP | Over voltage protection | $T_{P1} = +25^{\circ}C$, $V_{I} = 48 \text{ V}$, 0-100% of max I_{O} | | 38 | | V |
| | Sink current, see Note 3 | See operating information | | 0.2 | | mA |
| RC | Trigger level | See operating information | | 1.4 | | V |

Note 1: Minimum 0.5W load is required to guaranty line and load regulation at Vin_max = 60V.

Note 2: External 82.94kohm resistance on the Vadj-pin, see operating information.

Note 3: Sink current drawn by external device connected to the RC pin.

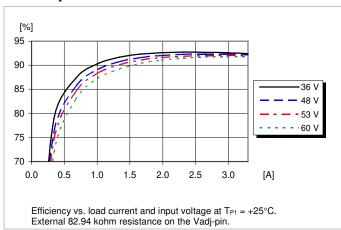
Note 4: Low ESR value



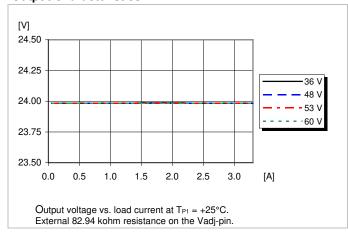
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Typical Characteristics 24 V, 3.3 A / 80 W

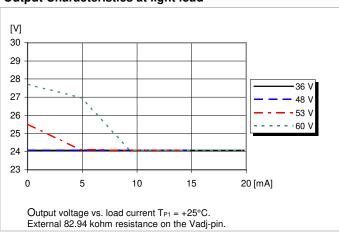
Efficiency



Output Characteristics

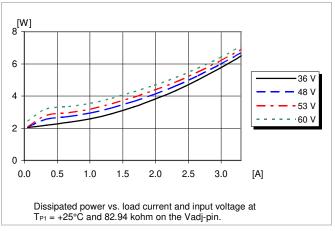


Output Characteristics at light load

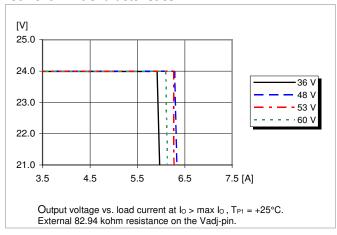


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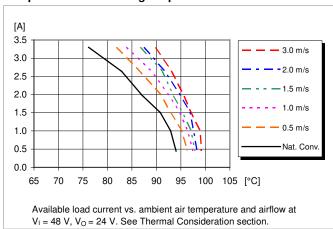
Power Dissipation



Current Limit Characteristics



Output Current Derating - Open frame





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| Input 36-75 V, Output up to 3.3 A /100 W | © Flex | |

Electrical Specification 30 V, 3.3 A / 100 W

PKU 4116C

 T_{P1} = -30 to +95°C, V_{I} = 36 to 75 V, unless otherwise specified under Conditions. Typical values given at: T_{P1} = +25°C, V_{I} = 48 V, max I_{O} , unless otherwise specified under Conditions. Additional C_{in} = 47 μ F, C_{out} = 47 ν F. See Operating Information section for selection of capacitor types.

| Chara | cteristics | Conditions | min | typ | max | Unit |
|------------------|----------------------------|---|-----|------|------|------|
| Vı | Input voltage range | | 36 | | 75 | V |
| V_{loff} | Turn-off input voltage | Decreasing input voltage | 33 | 34 | 35 | V |
| V _{Ion} | Turn-on input voltage | Increasing input voltage | 34 | 35 | 36 | V |
| Cı | Internal input capacitance | | | 5 | | μF |
| Po | Output power | See note 1 | 1 | | 100 | W |
| | | 50% of max I _O | | 92.3 | | % |
| | | max I _O | | 93.1 | | |
| η | Efficiency | 50% of max I _O , V _I = 53 V | | 92.0 | | |
| | | $max I_O, V_I = 53 V$ | | 93.0 | | |
| P_d | Power Dissipation | max I _O | | 7.4 | 10.9 | W |
| Pii | Input idling power | $I_0 = 0 \text{ A}, V_1 = 48 \text{ V}$ | | 1.8 | | W |
| P _{RC} | Input standby power | V _I = 48 V (turned off with RC) | | 0.26 | | W |
| fs | Switching frequency | 0-100 % of max I _O | 370 | 415 | 460 | kHz |

| V _{Oi} | Output voltage initial setting and accuracy | $T_{P1} = +25^{\circ}C, V_1 = 48 \text{ V}, I_0 = 3.3 \text{ A}$ | 29.7 | 30 | 30.3 | V |
|------------------|---|---|-------|-----|-------|-------|
| | Output adjust range | See operating information | 10 | | 33 | V |
| | Output voltage tolerance band | 1-100% of max I _O | 29.55 | | 30.45 | V |
| V_{O} | Idling voltage | I _O = 0 A | 29.55 | | 41 | V |
| | Line regulation | $max I_{O_1} V_O = 30 V$ | | 1 | 9 | mV |
| | Load regulation | $V_1 = 48 \text{ V}, 1-100\% \text{ of max } I_0$ | | 0 | 10 | mV |
| V_{tr} | Load transient voltage deviation | V ₁ = 48 V, Load step 25-75-25% of max I _O , di/dt = 1 A/μs, C _O = 1mF | | 400 | 650 | mV |
| t _{tr} | Load transient recovery time |] | | 0.6 | 1.5 | ms |
| t _r | Ramp-up time (from 10-90% of Voi) | 10-100% of max I _O | | 6.5 | 10 | ms |
| ts | Start-up time (from V _I connection to 90% of V _{Oi}) | 10-100 % of filax 1 ₀ | | 8 | 10 | ms |
| t _f | V _I shut-down fall time | max I _O | | 1.5 | | ms |
| 4 | (from V _I off to 10% of V _O) | $I_O = 0 A$ | | 12 | | S |
| | RC start-up time | max I _O | | 115 | | ms |
| t_{RC} | RC shut-down fall time | max I _O | | 1.5 | | ms |
| | (from RC off to 10% of V _O) | I _O = 0 A | | 12 | | S |
| Io | Output current | See note 1 | 0.033 | | 3.3 | Α |
| I _{lim} | Current limit threshold | $T_{P1} < max T_{P1}$ | 3.3 | 5.3 | 6.7 | Α |
| I _{sc} | Short circuit current | T _{P1} = 25 ^o C, hic-up mode | | 4.5 | 5.5 | Α |
| Cout | Recommended Capacitive Load | $T_{P1} = 25^{\circ}C$, see Note 2 | 47 | | 1000 | μF |
| V_{Oac} | Output ripple & noise | See ripple & noise section, V _{Oi} | | 30 | 60 | mVp-p |
| OVP | Over voltage protection | $T_{P1} = +25$ °C, $V_{I} = 48$ V, 0-100% of max I_{O} | | 38 | | V |
| RC | Sink current, see Note 3 | See operating information | | 0.2 | | mA |
| ΝU | Trigger level | See operating information | | 1.4 | | V |

Note 1: Minimum 1W load is required to guaranty line and load regulation.

Note 2: Low ESR value

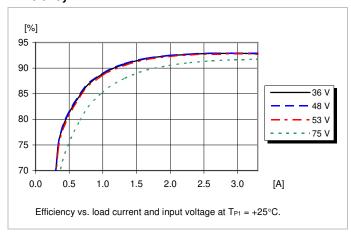
Note 3: Sink current drawn by external device connected to the RC pin.



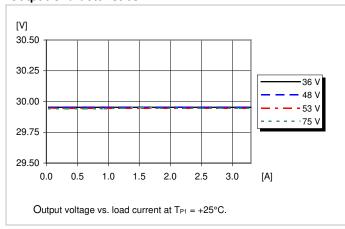
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Typical Characteristics 30.0 V, 3.3 A / 100 W

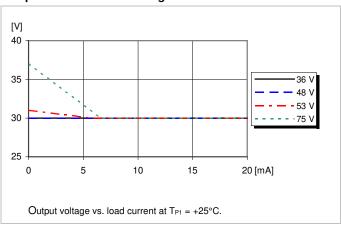
Efficiency



Output Characteristics

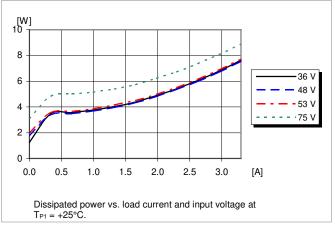


Output Characteristics at light load

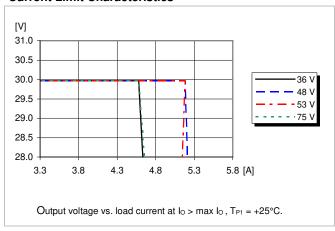


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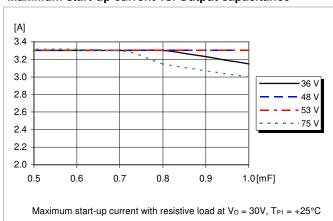
Power Dissipation



Current Limit Characteristics



Maximum start-up current vs. Output capacitance



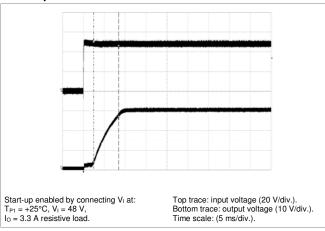


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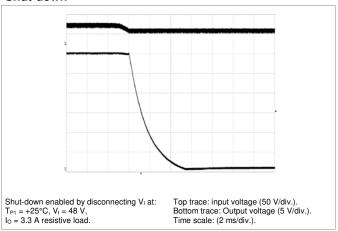
Typical Characteristics 30.0 V, 3.3 A / 100 W

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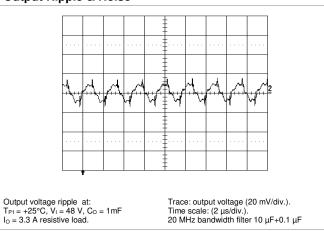
Start-up



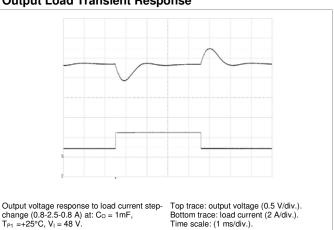
Shut-down



Output Ripple & Noise



Output Load Transient Response



Output Voltage Adjust (see operating information)

Passive adjust

The resistor value for an adjusted output voltage is calculated by using the following equations:

Output Voltage Adjust, Decrease:

$$Radj = \left(\frac{2200}{\Delta\%} - 27.06\right)^{-1} k\Omega$$

Output Voltage Adjust, Increase:

$$Radj = \left(\frac{22 \times 30(100 + \Delta\%)}{1.225 \times \Delta\%} - \frac{2200}{\Delta\%} - 27.06\right)^{\text{k}\Omega}$$

Example: Increase $4\% => V_0 = 31.2 \text{ Vdc}$

$$\left(\frac{22 \times 30(100 + 4)}{1.225 \times 4} - \frac{2200}{4} - 27.06\right)^{-1.2 \text{ Vol}} \text{ k}\Omega = 13 \text{ 431 k}\Omega$$

Resistor Value

| Output Voltage (V) | Resistor Value Vadj-pin (kΩ) |
|--------------------|------------------------------|
| 30 | - |
| 28 | 302.94 |
| 24 | 82.94 |
| 20 | 38.94 |
| 15 | 16.94 |
| 10 | 5.94 |

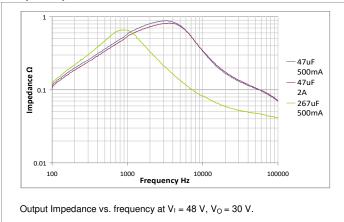


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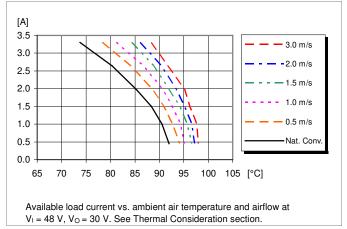
Typical Characteristics 30 V, 3.3 A / 100 W

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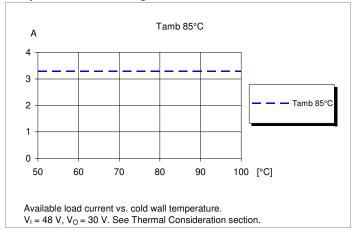
Output Impedance



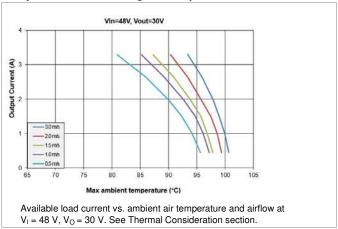
Output Current Derating – Open frame



Output Current Derating - Cold wall sealed box



Output Current Derating – Base plate





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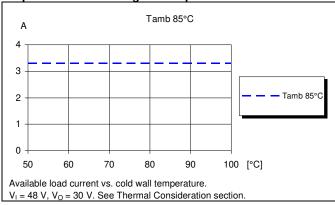


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| Input 36-75 V, Output up to 3.3 A /100 W | © Flex | |

Typical Characteristics 30 V, 3.3 A / 100 W

PKU 4116C







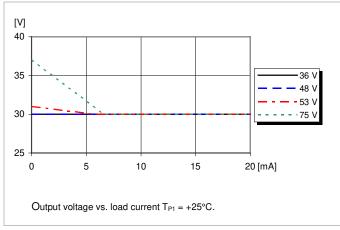
| PKU4116C Series Direct Converters |
|--|
| Input 36-75 V, Output up to 3.3 A /100 V |

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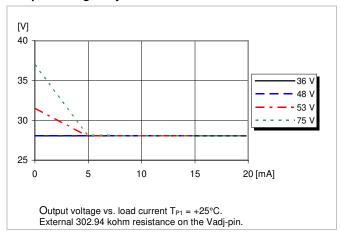
Typical Characteristics 30 V, 3.3 A / 100 W

Typical Output Characteristics at light load

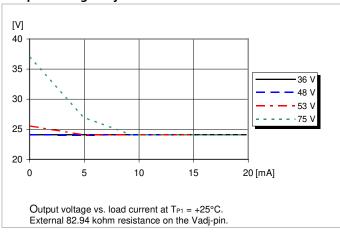
Output Voltage = 30V



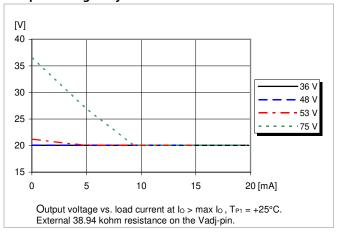
Output Voltage Adjust = 28V



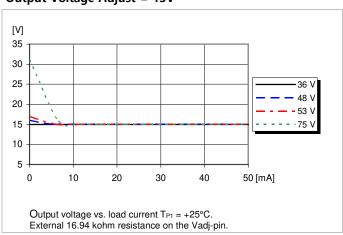
Output Voltage Adjust = 24V



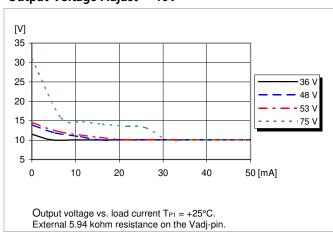
Output Voltage Adjust = 20V



Output Voltage Adjust = 15V



Output Voltage Adjust = 10V



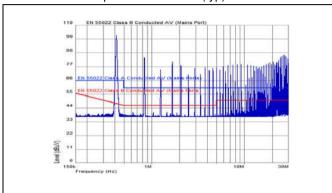


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EMC Specification

Conducted EMI measured according to EN55022, CISPR 22 and FCC part 15J (see test set-up). See Design Note 009 for further information. The fundamental switching frequency is 415 kHz for PKU 4116C at $V_I = 48$ V and max I_O .

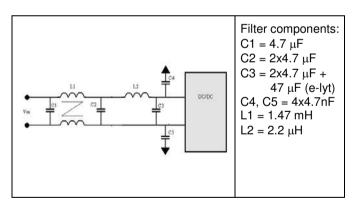
Conducted EMI Input terminal value (typ)

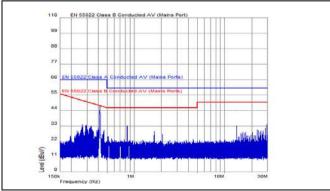


EMI without filter

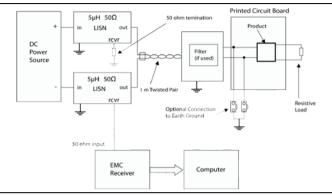
Minimum external filter for class B

Suggested external input filter in order to meet class B in EN 55022, CISPR 22 and FCC part 15J. Filter optimized for minimum PWB area.





EMI with filter



Test set-up

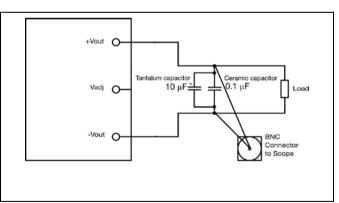
Layout recommendations

The radiated EMI performance of the product will depend on the PWB layout and ground layer design. It is also important to consider the stand-off of the product. If a ground layer is used, it should be connected to the output of the product and the equipment ground or chassis.

A ground layer will increase the stray capacitance in the PWB and improve the high frequency EMC performance.

Output ripple and noise

Output ripple and noise measured according to figure below. See Design Note 022 for detailed information.



Output ripple and noise test setup



PKU4116C Series Direct Converters Input 36-75 V, Output up to 3.3 A /100 W 28701-BMR67105 Rev.F September 2019 © Flex

Operating information

Input Voltage

The input voltage range 36 to 75 Vdc meets the requirements of the European Telecom Standard ETS 300 132-2 for normal input voltage range in –48 and –60 Vdc systems, -40.5 to -57.0 V and –50.0 to -72 V respectively.

At input voltages exceeding 75 V, the power loss will be higher than at normal input voltage and T_{P1} must be limited to absolute max +105°C. The absolute maximum continuous input voltage is 80 Vdc.

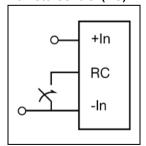
Short duration transient disturbances can occur on the DC distribution and input of the product when a short circuit fault occurs on the equipment side of a protective device (fuse or circuit breaker). The voltage level, duration and energy of the disturbance are dependant on the particular DC distribution network characteristics and can be sufficient to damage the product unless measures are taken to suppress or absorb this energy. The transient voltage can be limited by capacitors and other energy absorbing devices like zener diodes connected across the positive and negative input conductors at a number of strategic points in the distribution network. The end-user must secure that the transient voltage will not exceed the value stated in the Absolute maximum ratings. ETSI TR 100 283 examines the parameters of DC distribution networks and provides guidelines for controlling the transient and reduce its harmful effect.

Turn-off Input Voltage

The products monitor the input voltage and will turn on and turn off at predetermined levels.

The minimum hysteresis between turn on and turn off input voltage is 1 V.

Remote Control (RC)



The products are fitted with a remote control function referenced to the primary negative input connection (-In), with negative and positive logic options available. The RC function allows the product to be turned on/off by an external device like a semiconductor or mechanical switch. The RC pin has an internal pull up resistor.

The external device must provide a minimum required sink current to guarantee a voltage not higher than maximum voltage on the RC pin (see Electrical characteristics table). When the RC pin is left open, the voltage generated on the RC pin is 4 - 5 V.

The standard product is provided with "negative logic" RC and will be off until the RC pin is connected to the -ln. To turn off the product the RC pin should be left open, or connected to a voltage higher than 2 V referenced to -ln. In situations where it is desired to have the product to power up automatically

without the need for control signals or a switch, the RC pin can be wired directly to -In.

The second option is "positive logic" remote control, which can be ordered by adding the suffix "P" to the end of the part number. When the RC pin is left open, the product starts up automatically when the input voltage is applied. Turn off is achieved by connecting the RC pin to the -In. The product will restart automatically when this connection is opened.

See Design Note 021 for detailed information.

Input and Output Impedance

The impedance of both the input source and the load will interact with the impedance of the product. It is important that the input source has low characteristic impedance. The source impedance, including the ESR value in the external capacitance shall be below 0.25Ω over the temperature range to prevent degradation of function and performance. The products are designed for stable operation with a minimum of 47 μF external capacitance with low ESR value connected to the input and output. The electrolytic capacitors will be degraded in low temperature and the ESR value may increase. The needed input capacitance in low temperature should be equivalent to 47 µF at 20° C. This means that the input capacitor value may need to be substantially larger to quarantee a stable input at low temperatures. The performance in some applications can be enhanced by addition of external capacitance as described under External Decoupling Capacitors.

External Decoupling Capacitors

When powering loads with significant dynamic current requirements, the voltage regulation at the point of load can be improved by addition of decoupling capacitors at the load. The most effective technique is to locate low ESR ceramic and electrolytic capacitors as close to the load as possible, using several parallel capacitors to lower the effective ESR. The ceramic capacitors will handle high-frequency dynamic load changes while the electrolytic capacitors are used to handle low frequency dynamic load changes. It is equally important to use low resistance and low inductance PWB layouts and cabling.

External decoupling capacitors will become part of the product's control loop. The control loop is optimized for a wide range of external capacitance and the maximum recommended value that could be used without any additional analysis is found in the Electrical specification. The ESR of the capacitors is a very important parameter. Stable operation is guaranteed with a verified ESR value of >10 m Ω across the output connections.

For further information please contact your local Flex representative.



PKU4116C Series Direct Converters Input 36-75 V, Output up to 3.3 A /100 W 28701-BMR67105 Rev.F September 2019 © Flex

Output Voltage Adjust (Vadi)

The products have an Output Voltage Adjust pin (V_{adj}) . This pin can be used to adjust the output voltage above or below Output voltage initial setting.

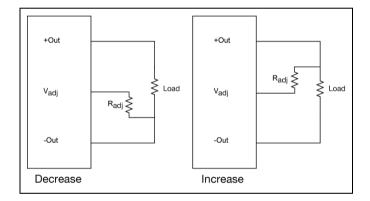
When increasing the output voltage, the voltage at the output pins must be kept below the threshold of the over voltage protection, (OVP) to prevent the product from shutting down. At increased output voltages the maximum power rating of the product remains the same, and the max output current must be decreased correspondingly.

To increase the voltage the resistor should be connected between the V_{adj} pin and +Out pin. The resistor value of the Output voltage adjust function is according to information given under the Output section for the respective product. To decrease the output voltage, the resistor should be connected between the V_{adj} pin and -Out pin.

continuous overload. The OCP works in a hiccup mode and will make continous attempts to start up and will resume normal operation automatically after removal of the over current condition. High input voltage in combination with deep short circuit can be harmful for the product. It is not recommended to short circuit the output if the input voltage is above 60V. The load distribution should be designed for the maximum output short circuit current specified.

Pre-bias Start-up

The product has a Pre-bias start up functionality and will not sink current during start up if a pre-bias source is present at the output terminals.



Parallel Operation

Two products may be paralleled for redundancy if the total power is equal or less than P_{O} max. No external circuits are needed.

See Design Note 006 for detailed information.

Over Temperature Protection (OTP)

The products are protected from thermal overload by an internal over temperature shutdown circuit.

When T_{P1} as defined in thermal consideration section exceeds 120°C the product will shut down. The product will make continuous attempts to start up (non-latching mode) and resume normal operation automatically when the temperature has dropped >10°C below the temperature threshold.

Over Voltage Protection (OVP)

The products have output over voltage protection that will shut down the product in over voltage conditions. The product will resume normal operation automatically after removal of the over voltage condition.

Over Current Protection (OCP)

The products include current limiting circuitry for protection at



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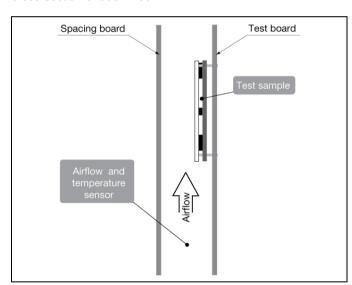
Thermal Consideration

General

The products are designed to operate in different thermal environments and sufficient cooling must be provided to ensure reliable operation.

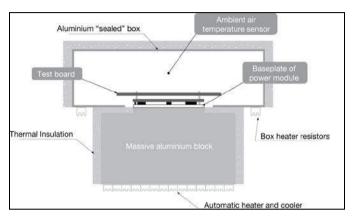
For products mounted on a PWB without a heat sink attached, cooling is achieved mainly by conduction, from the pins to the host board, and convection, which is dependant on the airflow across the product. Increased airflow enhances the cooling of the product. The Output Current Derating graph found in the Output section for each model provides the available output current vs. ambient air temperature and air velocity at $V_1 = 48 \ V$.

The product is tested on a 254 x 254 mm, 35 μ m (1 oz), 16-layer test board mounted vertically in a wind tunnel with a cross-section of 608 x 203 mm.



For products with gap-pad used in a sealed box/cold wall application, cooling is achieved mainly by conduction through the cold wall. The Output Current Derating graphs are found in the Output section for each model. The product is tested in a sealed box test set up with ambient temperatures 85 °C. See Design Note 028 for further details.

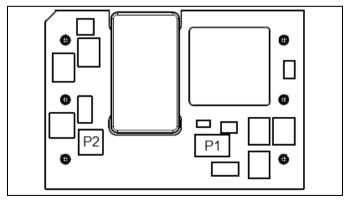
Gap-pad between cold wall and module ferrites: Bergquist 5000S35, 2mm compressed to 1.2mm. Hardness shore (00) 35. Thermal conductivity 5.0 W/m-K



Definition of product operating temperature

The product operating temperatures is used to monitor the temperature of the product, and proper thermal conditions can be verified by measuring the temperature at positions P1, P2. The temperature at these positions (T_{P1} , T_{P2}) should not exceed the maximum temperatures in the table below. The number of measurement points may vary with different thermal design and topology. Temperatures above maximum T_{P1} , measured at the reference point P1 are not allowed and may cause permanent damage.

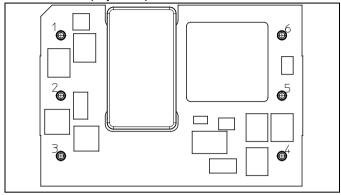
| Position | Description | Max Temp. |
|----------|-------------------------------|-------------------------|
| P1 | Reference point, Opto coupler | T _{P1} =105º C |
| P2 | Mosfet case | T _{P2} =125º C |





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|--|----------------------|----------------|
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Connections (top side)



| Pin | Designation | Function |
|-----|------------------|-----------------------|
| 1 | +In | Positive input |
| 2 | RC | Remote control |
| 3 | -In | Negative input |
| 4 | -Out | Negative output |
| 5 | V _{adj} | Output voltage adjust |
| 6 | +Out | Positive output |



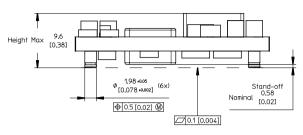
| PKU4116C Series Direct Converters |
|--|
| Input 36-75 V, Output up to 3.3 A /100 V |

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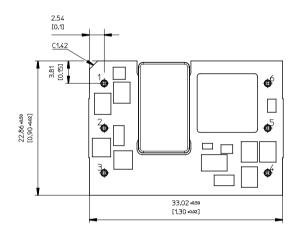
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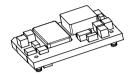
Mechanical Information - Surface Mount Version

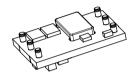


TOP VIEW

Pin positions according to recommended footprint

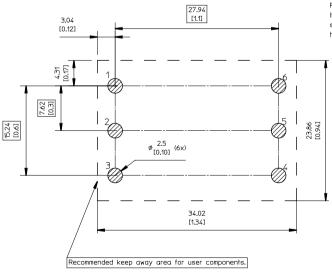






PIN SPECIFICATIONS Pin 1-6 Material: Copper alloy Plating: Min Au 0.1 µm over 1-3 µm Ni.

RECOMMENDED FOOTPRINT - TOP VIEW



Recommended pad dimensions are only for reference. It is the end users decision based on different situations like production processes, substrate thickness etc.

Weight: Typical 13.5 g
All dimensions in mm (inch)
Tolerances unless specified:
x.x ±0.50 (0.02),
x.xx±0.25 (0.01)
(not applied on footprint or typical values)



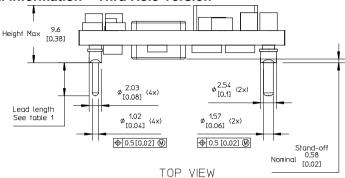


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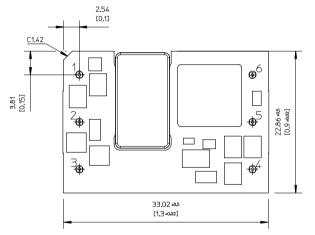
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Mechanical Information - Thru Hole Version



Pin positions according to recommended footprint

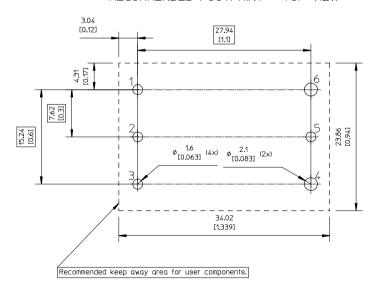


• Table 1

| Pin option | Lead length |
|------------|--------------|
| Standard | 5.33 [0.210] |
| LA | 3.69 [0.145] |
| LB | 4.57 [0.180] |
| LC | 2.79 [0.110] |

PIN SPECIFICATIONS Pin 1-6 Material: Copper alloy Plating: Min Au 0.1 µm over 1-3 µm Ni.

RECOMMENDED FOOTPRINT - TOP VIEW



Recommended hole dimensions are only for reference. It is the end users decision based on different situations like production processes, substrate thickness etc.

Weight: Typical 13.9 g
All dimensions in mm [inch]
Tolerances unless specified:
x.x ±0.50 [0.02],
x.xx±0.25 [0.01]
(not applied on footprint or typical values)



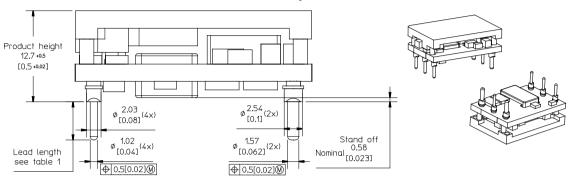


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Mechanical Information - Thru Hole Version with Baseplate



TOP VIEW Pin positions according to recommended footprint

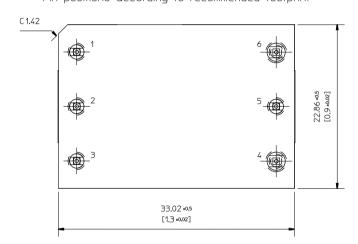


Table 1 Pin option Lead Length Standard 5.33 [0.210] 3.69 [0.145] LA

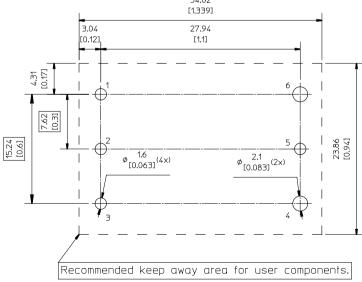
4.57 [0.180]

2.79 [0.110]

PIN SPECIFICATIONS

Pin 1–6 Material: Copper alloy Plating: Min Au 0.1 µm over 1-3 µm Ni.

RECOMMENDED FOOTPRINT - TOP VIEW 34.02



CASE Material: Aluminium

LB LC

Recommended hole dimensions are only for reference. It is the end users decision based on different situations like production processes, substrate thickness etc.

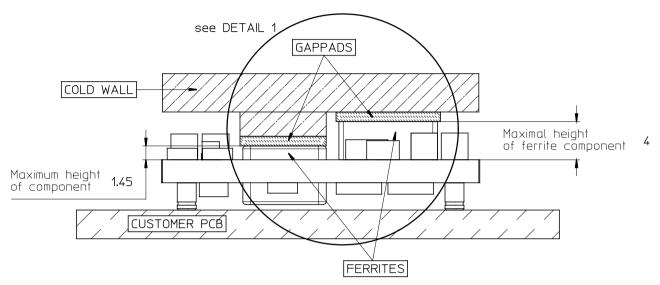
Weight: Typical 20.9 g All dimensions in mm [inch] Tolerances unless specified: x.x ±0.50 [0.02], x.xx±0.25 [0.01]

(not applied on footprint or typical values)





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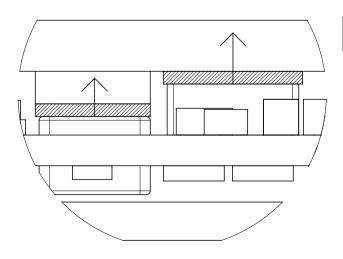
Thermal pad:

The thermal gap pads are intended to withdraw heat from ferrites and transport the heat through the thermal material to the cold wall.

The gap pads must be carefully chosen in accordance with thermal conductivity and mounting pressure.

To choose the correct gap filler material height difference between the two ferrites must taken into consideration.

Gappad 1 is intended to be the primary gap pad to withdraw heat and gap pad 2 to be a possible improvement gap pad if needed.



Heat transportation from ferrites to cold wall (see arrows)

DETAIL 1 Scale 4:1

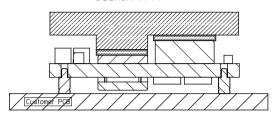


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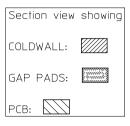
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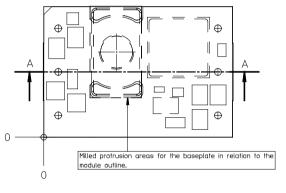
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Section A-A

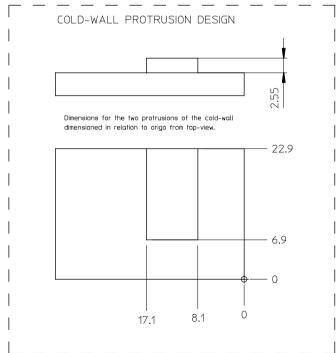


View above showing the milled protrusion for the ferrite and the two 1 mm gap pads (see hatch explanation in right box).





View to the left shows module from top through the coldwall showing the two areas that needs to be milled to meet the FETs for optimal heat evacuation.





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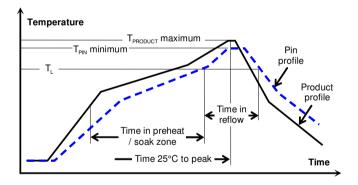
Soldering Information - Surface Mounting

The surface mount product is intended for forced convection or vapor phase reflow soldering in SnPb and Pb-free processes.

The reflow profile should be optimised to avoid excessive heating of the product. It is recommended to have a sufficiently extended preheat time to ensure an even temperature across the host PWB and it is also recommended to minimize the time in reflow.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board, since cleaning residues may affect long time reliability and isolation voltage.

| General reflow process specifications | | SnPb eutectic | Pb-free |
|---|----------------------|---------------|-----------|
| Average ramp-up (T _{PRODUCT}) | | 3°C/s max | 3°C/s max |
| Typical solder melting (liquidus) temperature | T∟ | 183°C | 221°C |
| Minimum reflow time above T _L | | 60 s | 60 s |
| Minimum pin temperature | T _{PIN} | 210°C | 235°C |
| Peak product temperature | T _{PRODUCT} | 225°C | 260°C |
| Average ramp-down (T _{PRODUCT}) | | 6°C/s max | 6°C/s max |
| Maximum time 25°C to peak | | 6 minutes | 8 minutes |



Minimum Pin Temperature Recommendations

Pin number 3 chosen as reference location for the minimum pin temperature recommendation since this will likely be the coolest solder joint during the reflow process.

SnPb solder processes

For SnPb solder processes, a pin temperature (T_{PIN}) in excess of the solder melting temperature, (T_L, 183°C for Sn63Pb37) for more than 60 seconds and a peak temperature of 220°C is recommended to ensure a reliable solder joint.

For dry packed products only: depending on the type of solder paste and flux system used on the host board, up to a recommended maximum temperature of 245°C could be used, if the products are kept in a controlled environment (dry pack handling and storage) prior to assembly.

Lead-free (Pb-free) solder processes

For Pb-free solder processes, a pin temperature (T_{PIN}) in excess of the solder melting temperature (T_{L} , 217 to 221°C for SnAgCu solder alloys) for more than 60 seconds and a peak temperature of 245°C on all solder joints is recommended to ensure a reliable solder joint.

Maximum Product Temperature Requirements

Top of the product PWB near pin 6 is chosen as reference location for the maximum (peak) allowed product temperature (Tproduct) since this will likely be the warmest part of the product during the reflow process.

SnPb solder processes

For SnPb solder processes, the product is qualified for MSL 1 according to IPC/JEDEC standard J-STD-020C.

During reflow Tproduct must not exceed 225 °C at any time.

Pb-free solder processes

For Pb-free solder processes, the product is qualified for MSL 3 according to IPC/JEDEC standard J-STD-020C.

During reflow Tproduct must not exceed 260 °C at any time.

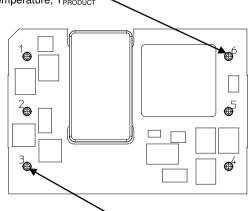
Dry Pack Information

Products intended for Pb-free reflow soldering processes are delivered in standard moisture barrier bags according to IPC/JEDEC standard J-STD-033 (Handling, packing, shipping and use of moisture/reflow sensitivity surface mount devices).

Using products in high temperature Pb-free soldering processes requires dry pack storage and handling. In case the products have been stored in an uncontrolled environment and no longer can be considered dry, the modules must be baked according to J-STD-033.

Thermocoupler Attachment

Top of PWB near pin 6 for measurement of maximum product temperature, $T_{PRODUCT}$



Pin 3 for measurement of minimum pin (solder joint) temperature, T_{PIN}



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Soldering Information - Hole Mounting

The hole mounted product is intended for plated through hole mounting by wave or manual soldering. The pin temperature is specified to maximum to 270°C for maximum 10 seconds.

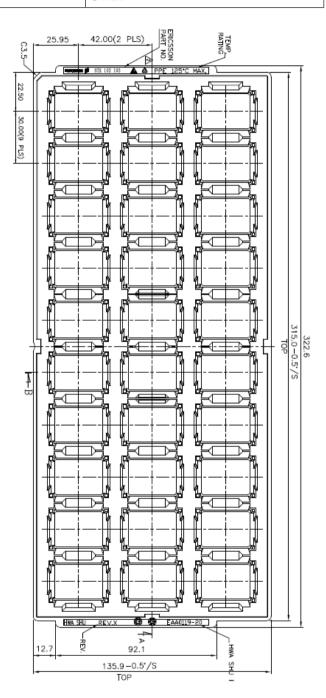
A maximum preheat rate of 4°C/s and maximum preheat temperature of 150°C is suggested. When soldering by hand, care should be taken to avoid direct contact between the hot soldering iron tip and the pins for more than a few seconds in order to prevent overheating.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board. The cleaning residues may affect long time reliability and isolation voltage.

Delivery Package Information

The products are delivered in antistatic injection molded trays (Jedec design guide 4.10D standard), antistatic carrier tape (EIA 481 standard), or antistatic foam trays.

| Tray Specifications – SMD /Pin in paste | | |
|---|--|--|
| Material | Antistatic PPE | |
| Surface resistance | 10 ⁵ < Ohm/square < 10 ¹¹ | |
| Bakability | The trays can be baked at maximum 125°C for 48 hours | |
| Tray thickness | 18.50 mm 0.728 [inch] | |
| Box capacity | 150 products (5 full trays/box) | |
| Tray weight | 125 g empty, 500 g full tray | |



JEDEC standard tray for 3x10 = 30 products. All dimensions in mm [inch] Tolerances: X.x ±0.26 [0.01], X.xx ±0.13 [0.005] Note: pick up positions refer to center of pocket. See mechanical drawing for exact location on product.

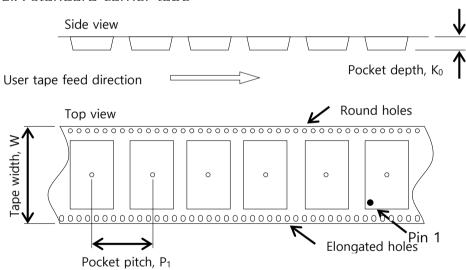
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| Carrier Tape Specifications | | | | |
|------------------------------|---|---|--|--|
| | Through hole version | SMD version | | |
| Material | Antistatic PS | Antistatic PS | | |
| Surface resistance | 10 ⁵ < Ohm/square < 10 ¹¹ | 10 ⁵ < Ohm/square < 10 ¹¹ | | |
| Bakeability | The tape is not bakable | The tape is not bakable | | |
| Tape width, W | 56 mm [2.205 inch] | 56 mm [2.205 inch] | | |
| Pocket pitch, P ₁ | 36 mm [1.417inch] | 36 mm [1.417inch] | | |
| Pocket depth, K ₀ | 15.43 mm [0.607 inch] | 9.74 mm [0.383 inch] | | |
| Reel diameter | 381 mm [15 inch] | 381 mm [15 inch] | | |
| Reel capacity | 120 products /reel | 170 products /reel | | |
| Reel weight | 2.3 kg/full reel estimate | 3.0 kg/full reel estimate | | |

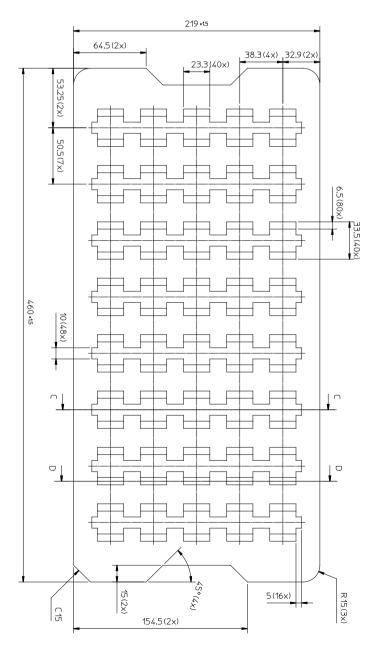
EIA standard carrier tape





| PKU4116C Series Direct Converters | 28701-BMR67105 Rev.F | September 2019 |
|--|----------------------|----------------|
| Input 36-75 V, Output up to 3.3 A /100 W | © Flex | |

| Tray Specifications – Base plate version without dry pack | | | | |
|---|---|--|--|--|
| Material | PE Foam | | | |
| Surface resistance | 10 ⁵ < Ohm/square < 10 ¹¹ | | | |
| Bakability | The trays cannot be baked | | | |
| Tray capacity | 40 converters/tray | | | |
| Box capacity | 40 products (1 full trays/box) | | | |
| Tray Weight | Product – Base plate 900 g full tray, 60g empty tray | | | |





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Product Qualification Specification

| Characteristics | | | | | | |
|---|--|---|--|--|--|--|
| External visual inspection | IPC-A-610 | | | | | |
| Change of temperature (Temperature cycling) | IEC 60068-2-14 Na | Temperature range Number of cycles Dwell/transfer time | -40 to 100°C 1000 15 min/0-1 min | | | |
| Cold (in operation) | IEC 60068-2-1 Ad | Temperature T _A Duration | -45°C 72 h | | | |
| Damp heat | IEC 60068-2-67 Cy | Temperature Humidity Duration | 85°C 85 % RH 1000 hours | | | |
| Dry heat | IEC 60068-2-2 Bd | Temperature Duration | 125°C 1000 h | | | |
| Electrostatic discharge susceptibility | IEC 61340-3-1, JESD 22-A114 IEC 61340-3-2, JESD 22-A115 | Human body model (HBM) Machine Model (MM) | Class 1B, 500 V Class 3, 200 V | | | |
| Immersion in cleaning solvents | IEC 60068-2-45 XA, method 2 | Water Glycol ether Isopropyl alcohol | 55°C 35°C 35°C | | | |
| Mechanical shock | IEC 60068-2-27 Ea | Peak acceleration Duration | 100 g 6 ms | | | |
| Moisture reflow sensitivity ¹ | J-STD-020C | Level 1 (SnPb-eutectic) Level 3 (Pb Free) | 225°C 260°C | | | |
| Operational life test | MIL-STD-202G, method 108A | Duration | 1000 h | | | |
| Resistance to soldering heat ² | IEC 60068-2-20 Tb, method 1A | Solder temperature Duration | 270°C 10-13 s | | | |
| Robustness of terminations | IEC 60068-2-21 Test Ua1 IEC 60068-2-21 Test Ue1 | Through hole mount products Surface mount products | All leads All leads | | | |
| Solderability | IEC 60068-2-58 test Td ¹ | Preconditioning Temperature, SnPb Eutectic Temperature, Pb-free | 150°C dry bake 16 h 215°C 235°C | | | |
| | IEC 60068-2-20 test Ta ² | Preconditioning Temperature, SnPb Eutectic Temperature, Pb-free | Steam ageing 235°C 245°C | | | |
| Vibration, broad band random | IEC 60068-2-64 Fh, method 1 | Frequency Spectral density Duration | 10 to 500 Hz 0.07 g ² /Hz 10 min in each direction | | | |

Notes

Only for products intended for reflow soldering (surface mount products)
 Only for products intended for wave soldering (plated through hole products)